

# XMC1302

32-bit Microcontroller Series for Industrial Applications

## Server Fan Control Reference Design

AP32294

### Application Note

#### About this document

This document is designed for the low voltage server fan motor drive application and based on XMC1302. This application is designed to implement sensorless FOC drive to minimize the server fan motor vibration effect.

#### Scope and purpose

To show how to implement the control with XMC1302 microcontroller to drive BLDC and PMSM server fan motor with Sensorless Field Oriented Control.

#### Intended audience

Server Fan motor manufacturers and design engineers who intend to reduce the system cost, improve efficiency, and shorten the application development cycle.

#### Applicable Products

- XMC1302
- BSL308C
- BC848W
- IFX20001MB
- DAVE™

#### References

The User's Manual can be downloaded from <http://www.infineon.com/XMC>.

DAVE™ and its resources can be downloaded from <http://www.infineon.com/DAVE>

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# 1 Introduction

The Infineon 'Server Fan Reference Design' is a complete solution for a low-voltage fan motor drive application (a BLDC and PMSM server fan motor), with low noise, minimal motor vibration, and a very low external component count. This application is typically used to supply cooling air to electronic equipments. The compact design is based around the Infineon 32-bit ARM® Cortex™ XMC1302 microcontroller with ready-to-use sensorless Field Oriented Control (FOC) firmware to support fast implementation into existing development platforms. The XMC1302 is a low-cost, high-performance microcontroller, and has flexible ADC features, Capture Compare Units (CCU4/8), and a Math Co-processor.

The PCB layout has a unique 'coin concept'. The spacing on the PCB board is utilized with surface mount components which results in lower BOM costs:

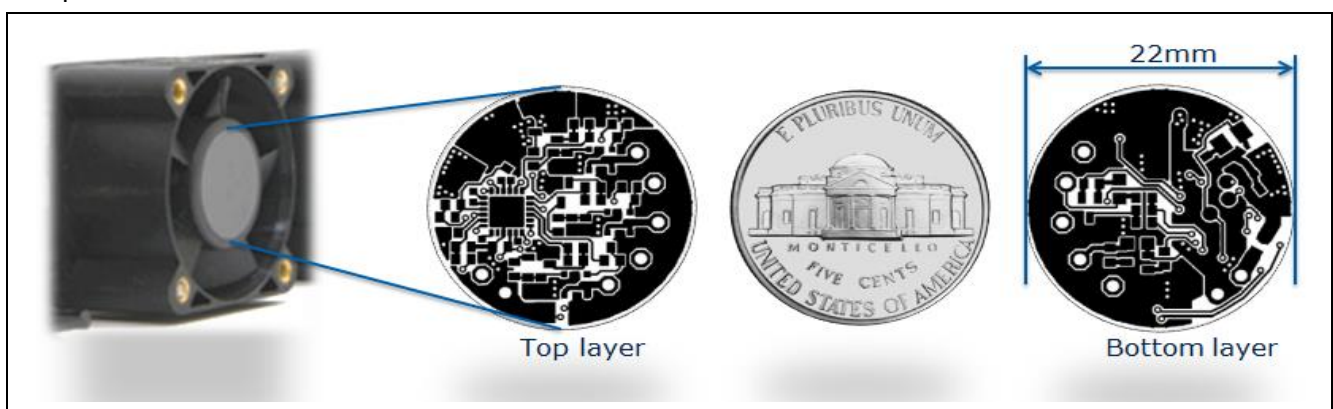


Figure 1 Server Fan PCB layout Coin Concept

## 1.1 XMC1302 Key Features

The XMC1302 is a low-cost microcontroller, optimized for motor control applications.

### Package types

- TSSOP-16
- VQFN-24
- TSSOP-28
- TSSOP-38
- VQFN-40

### XMC1302 as a controller for various types of motor

- Permanent Magnet Synchronous Motors (PMSM)
- Brushless DC Motors
- AC Induction Motors (ACIM)
- Servo Motors
- Brushed DC Motors

### Introduction

#### Key features

- High performance 32-bit Cortex-M0 CPU
- MATH Co-processor (MATH), consists of a CORDIC unit for trigonometric calculation and a division unit
- On-Chip Memories, 16 kbytes on-chip high-speed SRAM, up to 200 kbytes on-chip Flash program and data memory
- 12 channels 12-bit ADCs with hardware trigger
- Built-in Temperature Sensor
- Capture/Compare Units 4 (CCU4) for use as general purpose timers
- Capture/Compare Units 8 (CCU8) for motor control PWM generation
- Watchdog Timer (WDT) for safety sensitive applications

## 2 Reference Design Target Requirements

The reference design is intended to meet common server fan application specifications:

**Table 1** Reference Design Requirements

Item	Requirement
Motor Type	3 Phase PMSM motor
Motor Pole Pair	2 pp
Motor Resistance (per phase)	1.1 ~ 1.2 $\Omega$
Motor Inductance (per phase)	293 ~ 302 $\mu$ H (10 kHz)
PCB Layout Diameter	22 mm
Operating Voltage	12 V
Current Rating	1.00 A
Power Rating	12 W
Speed	0 to 25000 rpm
Fault Detection	Lock, reverse polarity
Over Current	Yes
Control Interface	POT / PWM input / FG Output
Control Algorithm	Field Oriented Control
Microcontroller	XMC1302 TSSOP16/VQFN24

*Note: All test waveforms are captured and shown later in this document.*

### 3 System Block Diagram

The hardware can be divided into four parts:

- Microcontroll (MCU)
  - The MCU consists of an XMC1302 ARM® Cortex™ with single-shunt Field Oriented Control (FOC) algorithm. It is used to control high-side and low-side transistors with adjustable dead-time.
- MOSFET stage
- Control interface
- Voltage regulator

This reference design uses ADC for current measurement with integrated gain in the XMC1302 microcontroller.

A two-wire SWD or single-wire SPD debugging interface is supported.

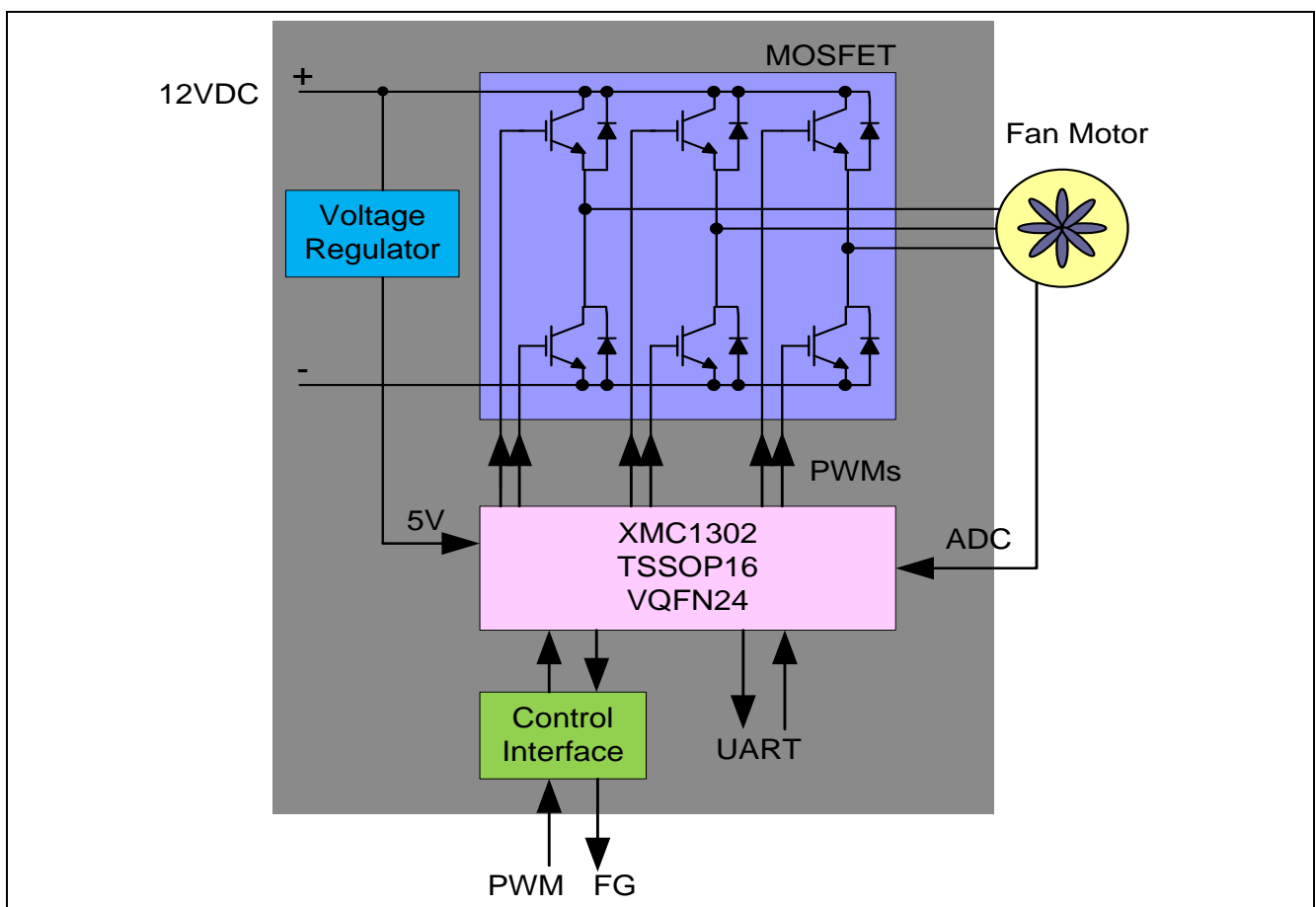


Figure 2 System Block Diagram

## 4 Motor Drive Features

The major requirements of server fan applications are for low audible noise and high efficiency. To boost the efficiency, design engineers need a means to offset the higher cost of a 3-phase fan motor compared to a single or dual-phase fan motor.

Most server fan motors are based on a 3-phase Brushless DC (BLDC) motor and Permanent Magnet Synchronous Motor (PMSM). While BLDC and PMSM motors have always been preferred for performance (efficiency, noise, starting torque), a complex and robust sensorless motor control algorithm is required.

### 4.1 Infineon Sensorless FOC algorithm with XMC1302

- Fast execution with hardware Math co-processor
- Optimized FOC block, without Inverse Park Transform
- Optimized Space Vector Modulation (SVM) using internal amplifier for single-shunt current sensing
- One single CORDIC calculation for Space Vector Modulation (SVM)
- Smooth and low-power start-up

## 5 Hardware Design

This reference design hardware includes single-shunt current measurement. The operating supply voltage of the hardware is 10V to 30V. It supports up to 25 kHz PWM switching frequency.

### 5.1 Form Factors

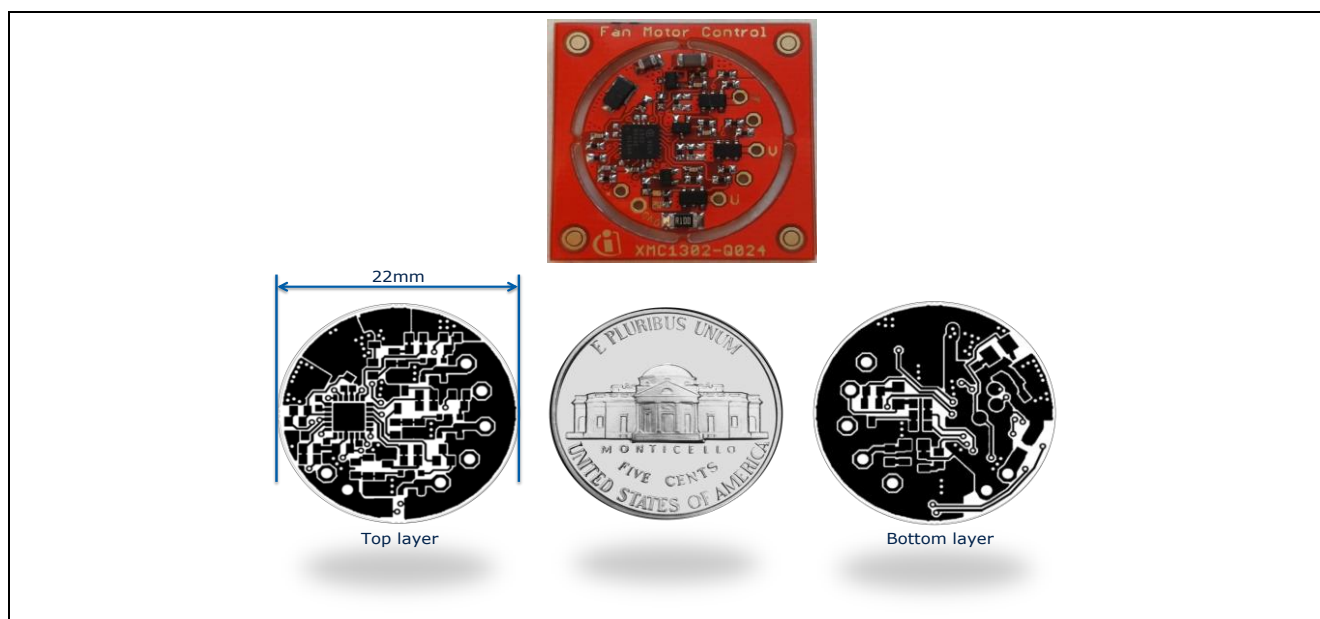


Figure 3 Diameter 22 mm with 2 layer Circular PCB layout

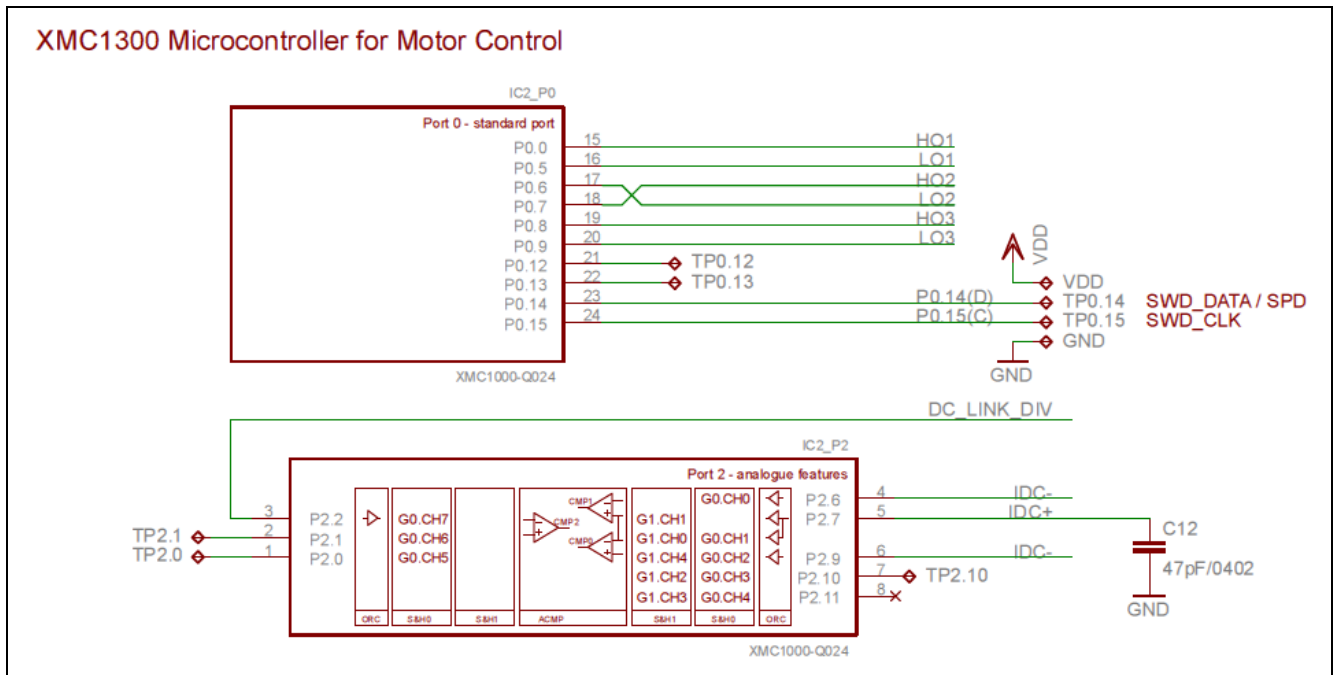
### 5.2 Pin Mapping

XMC1302-VQFN24			
S/N	Signal	Description	1-Shunt, CoinInverter
1	HO1	High side drive for Phase U MOSFET	P0.0 (CCU80.OUT00)
2	LO1	Low side drive for Phase U MOSFET	P0.5 (CCU80.OUT01)
3	HO2	High side drive for Phase V MOSFET	P0.7 (CCU80.OUT10)
4	LO2	Low side drive for Phase V MOSFET	P0.6 (CCU80.OUT11)
5	HO3	High side drive for Phase W MOSFET	P0.8 (CCU80.OUT20)
6	LO3	Low side drive for Phase W MOSFET	P0.9 (CCU80.OUT21)
7	IDC+	ADC for DC link current sensing	P2.7 (G1.CH1)
8	DC_LINK_DIV	Voltage of DC link (with voltage divider)	P2.2 (G0.CH7)
9	IN (PWM)	PWM duty cycle for speed adjustment	P1.1 (CCU40.IN1L)
10	OUT (FG/RD)	Voltage of DC link (with voltage divider)	P1.2 (CCU40.OUT2)
11	Debug	SWDIO_0 / SPD_0 / RX	P0.14
12	Debug	SWDCLK_0 / TX	P0.15

Figure 4 XMC1302 VQFN Pin assignment



### 5.3 Microcontroller Motor Control Ports



**Figure 5 XMC1302 Motor Control Ports**

#### Highlights

- XMC1302 ARM® Cortex™ - M0 32-bit microcontroller for motor control.
- Control of High-side and Low-side transistors with dead-time.
- ADC current measurement with adjustable gain.
- Support debug interface which includes two wire SWD or 1 wire SPD.
  - The non-isolated debug interface pins are connected directly to the controller.
- No external crystal or resonator is required. This helps for small size PCB layout.

## 5.4 MOSFET Stage

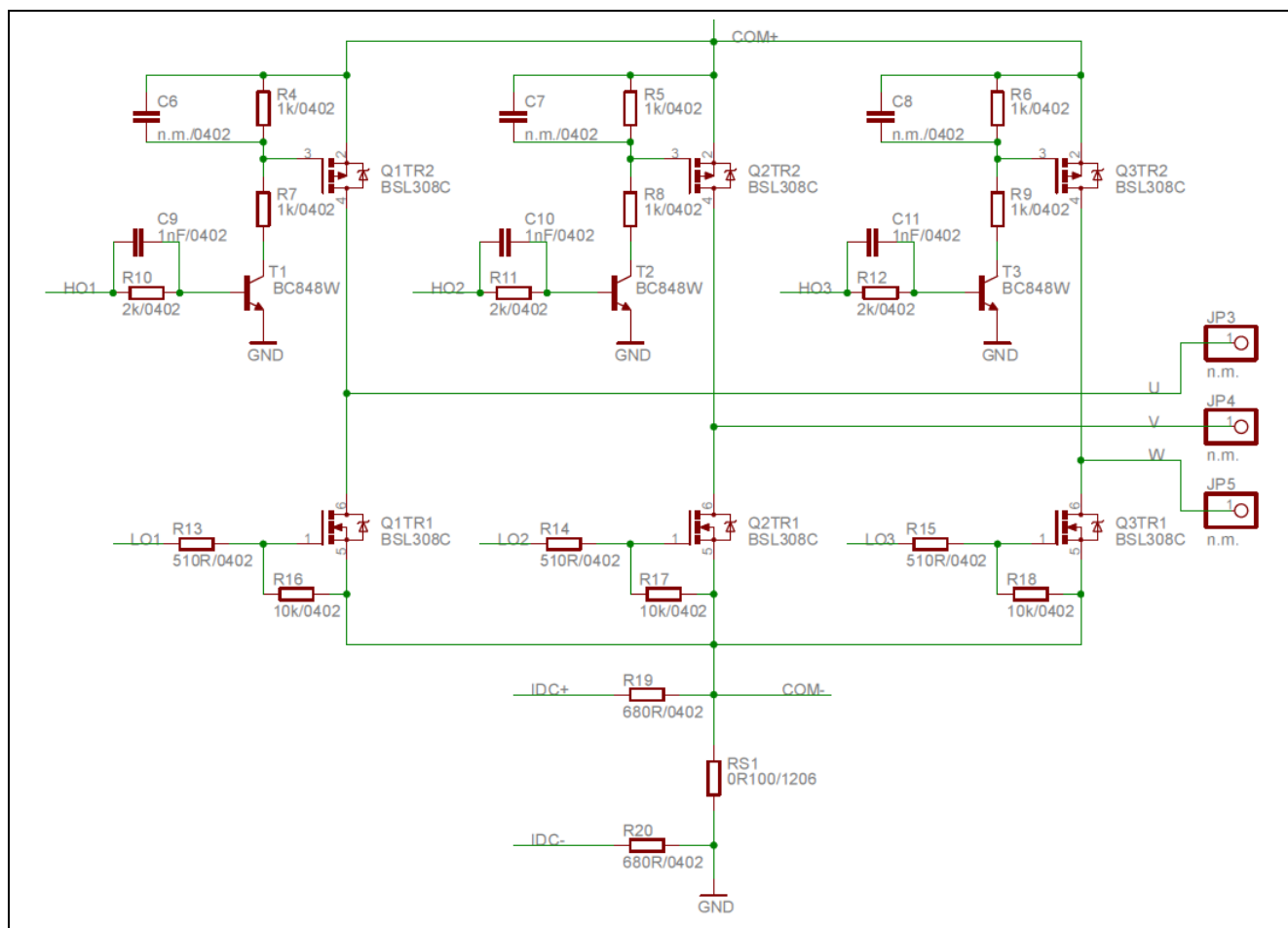


Figure 6 High Side and Low Side MOSFET circuitry

### Highlights

- Dual MOSFET switching with enhanced High-side driver circuitry.
- Direct drive of Low-side MOSFET.
- Single Shunt current sensing measurement.

### Control Interface

PWM IN:  
P1.1 -> USIC0 CH1.DX2(E)  
-> USIC0 CH1.DX2INS -> CCU40 CC41.IN1(L)

PWM OUT:  
P1.2 <- CCU40 CC42.OUT

UART:  
RX: P1.1 -> USIC0 CH1.DX0(D)  
TX: P1.2 <- USIC0 CH0.DOUT0

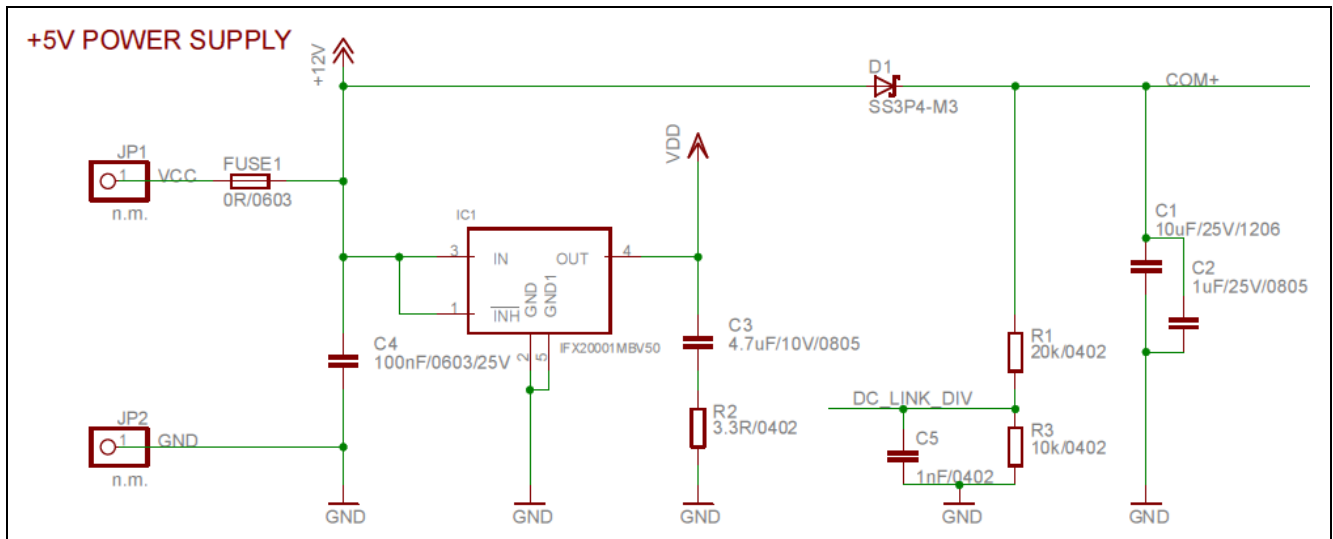
IC2\_P1  
Port 1 - high current port  
P1.0  
P1.1  
P1.2  
P1.3  
VDD  
EXP  
VSS  
XMC1000-Q024

**Figure 7**     **Interface circuitry with XMC1302**

## Highlights

- Speed control with PWM input including 12V level shifter.
- FG output with open collector circuitry for use in 12V domain.
- Two independent UART channels (RXD/TXD) with 12V level shifter (optional).

## 5.6 Power Supply



**Figure 8** Low Dropout Power Supply

### Highlights

- IFX20001MBV5 in small package SCT-595.
- Input voltage range up to 45V.
- Output voltage 5V, output current 30mA.
- Protection functions include over-temperature protection, and reverse polarity protection.
- Wide temperature range  $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$ .

## 6 Software State Machine

The Infineon Server Fan Control Reference Design software provides the following life-cycle states:

- Brake
  - When the board is powered on, braking is applied for position alignment.
- Start-up
  - The motor will start based on the voltage applied.
- Ramping
  - It performs speed adjustment (ramp-up or ramp-down).
- Transition
  - Maximum Efficiency Tracking (MET) is applied to increase transition from open loop to closed loop stability.
- Stop/Trip Protection
  - If any over-current protection is triggered, the motor will stop or stop-restart the operation.
- FOC PLL Observer
  - Closed loop algorithm to estimate the rotor position based on single shunt current feedback measurement.

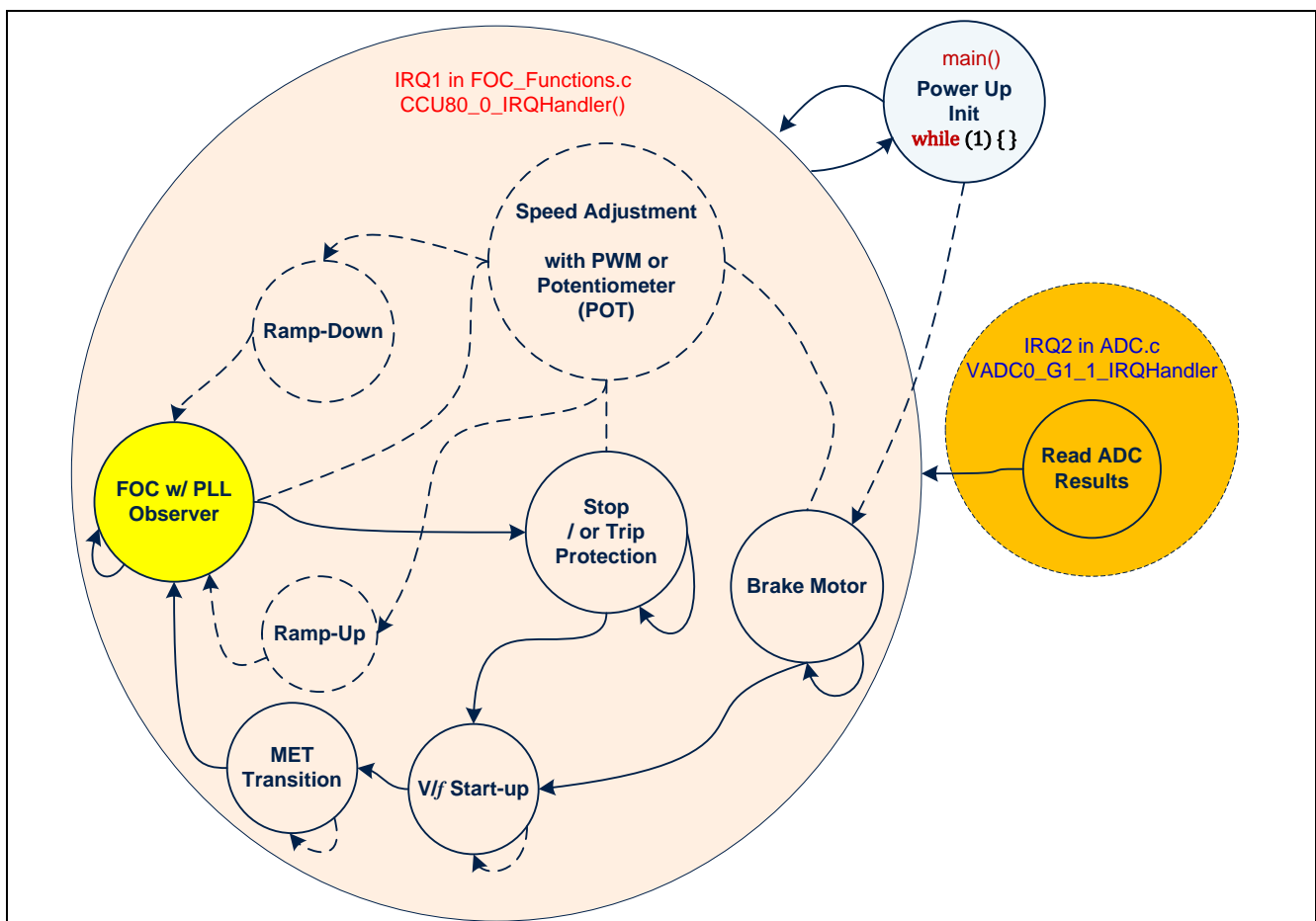


Figure 9 Software State Machine

## 7 Motor Control Test Data

### 7.1 Start-up Current Waveform

When the fan motor is at a standstill, it is impossible to sense positional information from motor back-EMF. Infineon server fan reference design provides FOC direct start-up control to achieve better efficiency.

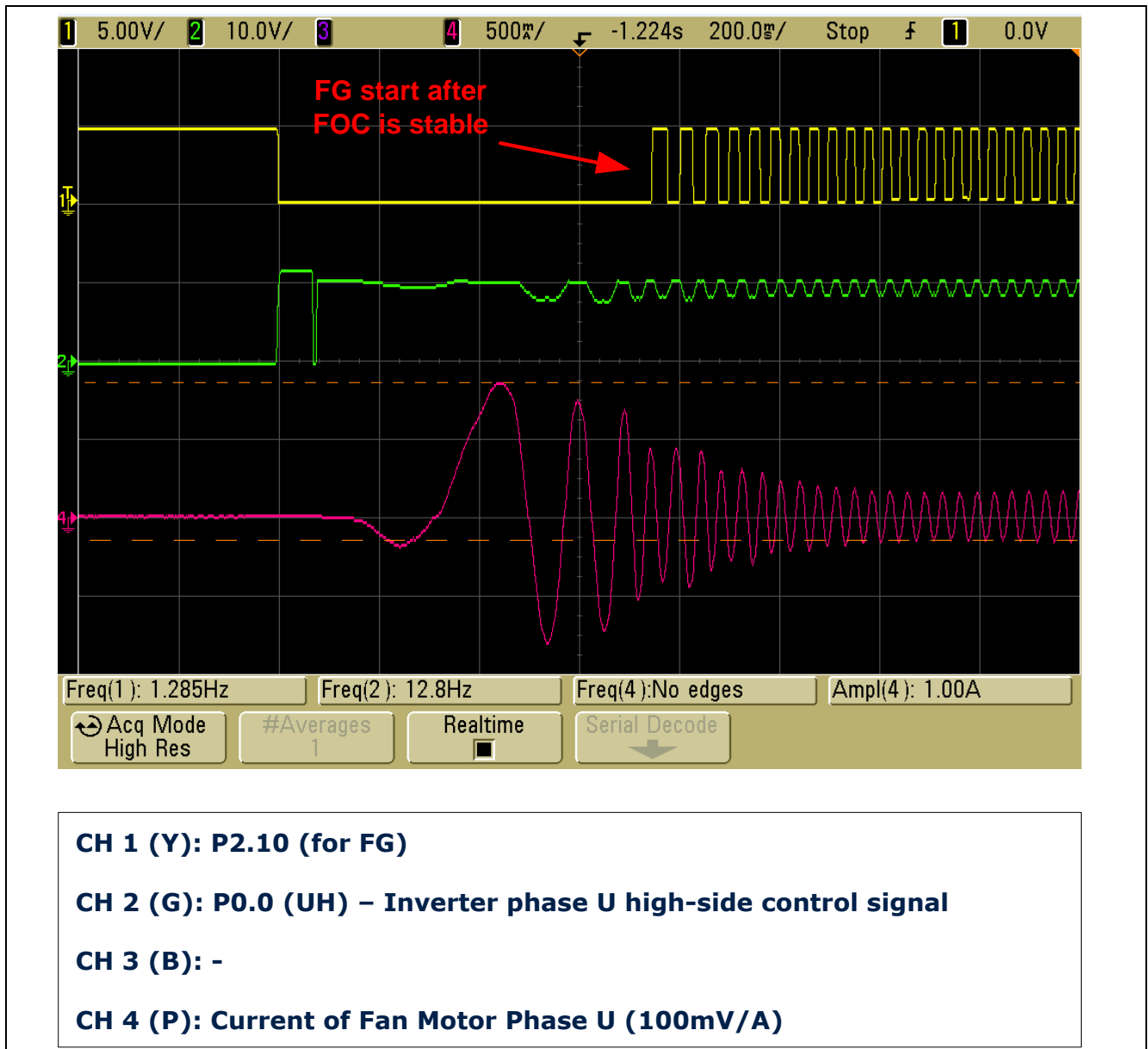


Figure 10 Direct FOC Start-up

## 7.2 Power Stage Inverter Dead-Time

To minimize the unwanted ripple in torque that may affect motor motion smoothness, the XMC1302 Capture Compare Unit (CCU4/8) provides flexible dead-time generation. This is used to generate a blanking time period (high-side and low-side transistor in off-state simultaneously). Both transistors are switched off for a short period of time to prevent the transistors conducting simultaneously and causing a short circuit from DC link voltage to ground. The CCU8 supports assymetric dead-time which is required in this application for efficient switching.

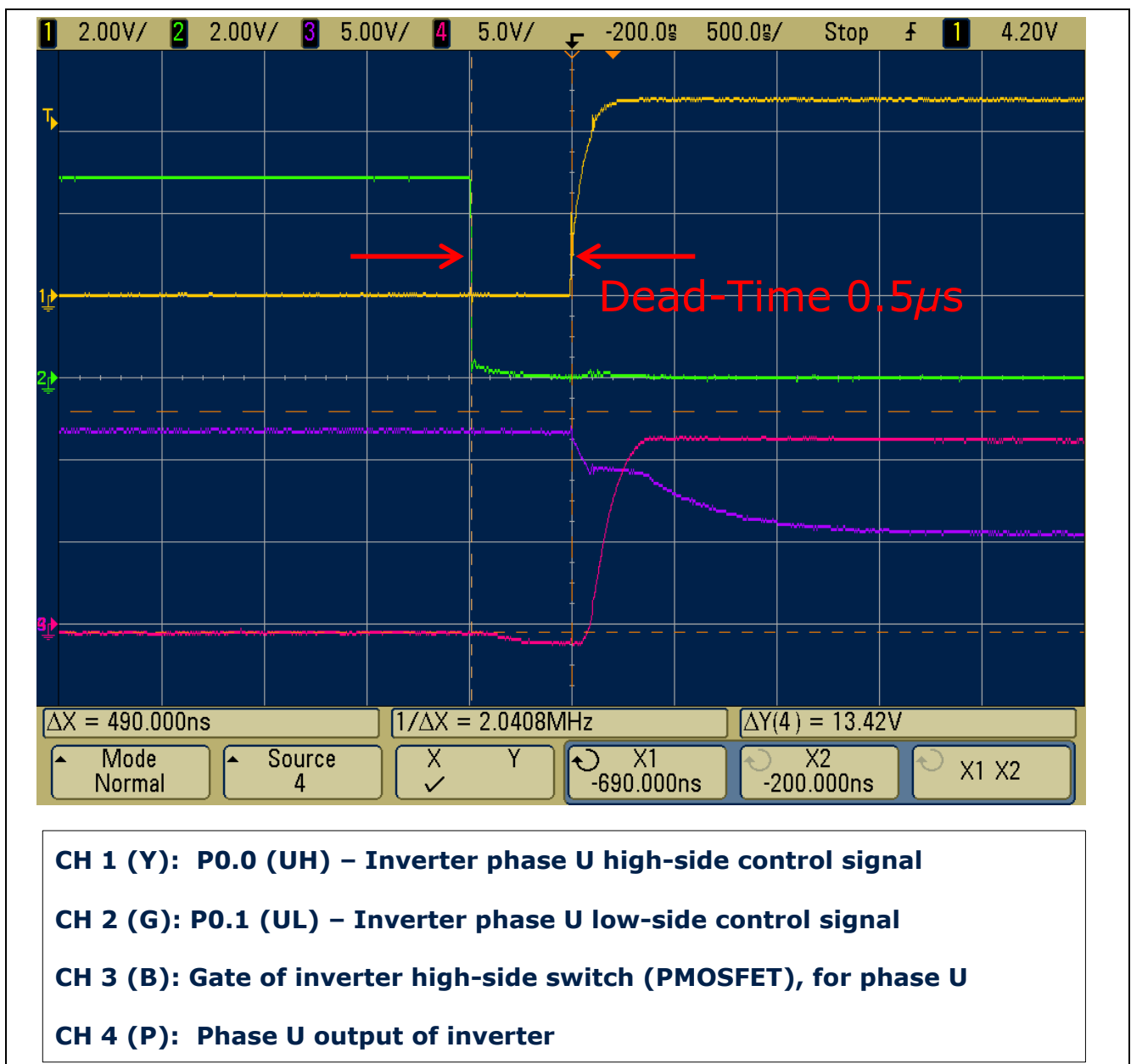


Figure 11 Phase U Rising Edge Output

Motor Control Test Data

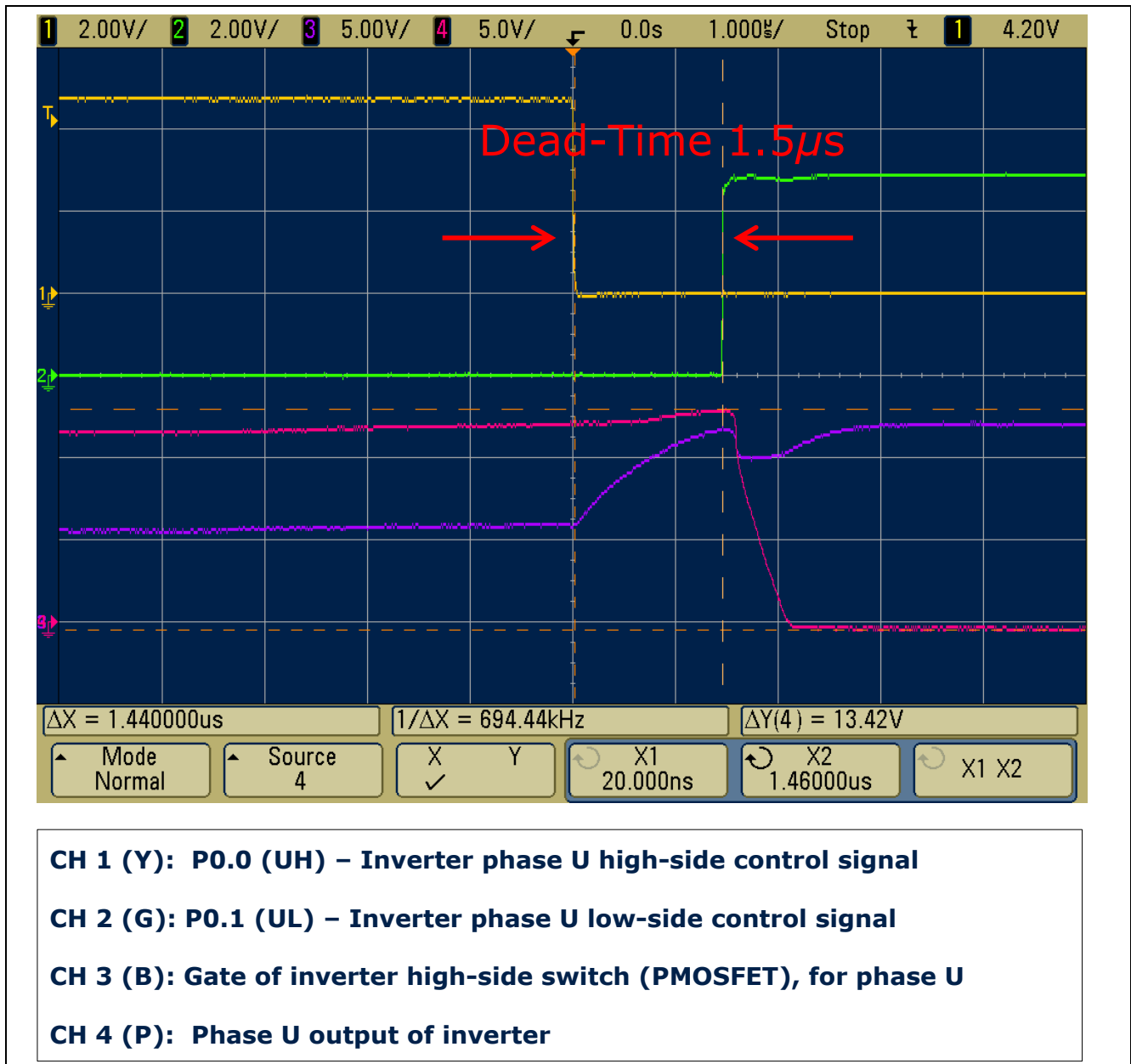


Figure 12 Phase U Failing Edge Output

To minimize the unwanted ripple in torque that may affect motor motion smoothness, XMC1302 Capture Compare Unit (CCU4/8) provides flexible dead-time generation. It is used to generate blanking time period (high-side and low-side transistor in off-state simultaneously). Both transistors are switched off for short period of time to prevent both transistors conducting simultaneously thus causing a short circuit from DC link voltage to ground. The CCU8 supports asymmetric dead-time which is required in this application for efficient switching.



### 7.3 Motor Steady-State Current Waveform

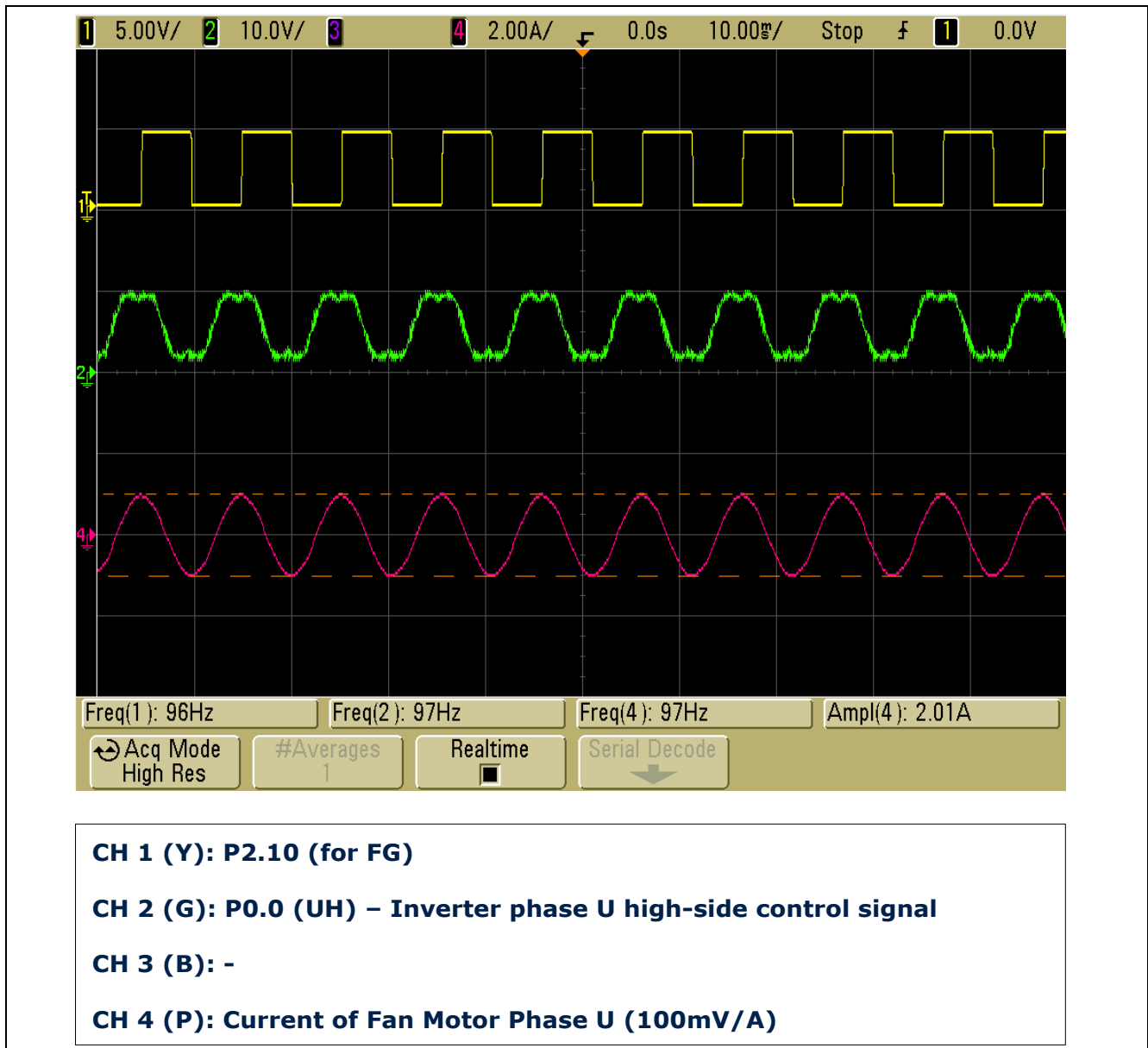


Figure 13 At steady state stage (FOC Closed Loop)

The Frequency Generator (FG) output is an important feature for server system. It is used as important feedback for the system to monitor the speed behavior of the Server Fan. For example, if the FG output is about 96Hz,

$$\omega = \frac{60 \times FG_{freq}}{n} = \frac{60 \times 96 \text{ Hz}}{2}$$

$$\omega = 2880$$

Where,

$\omega$  = Motor Speed (in rpm)

$n$  = No. of pole pairs

## 7.4 Motor High Speed Current Waveform

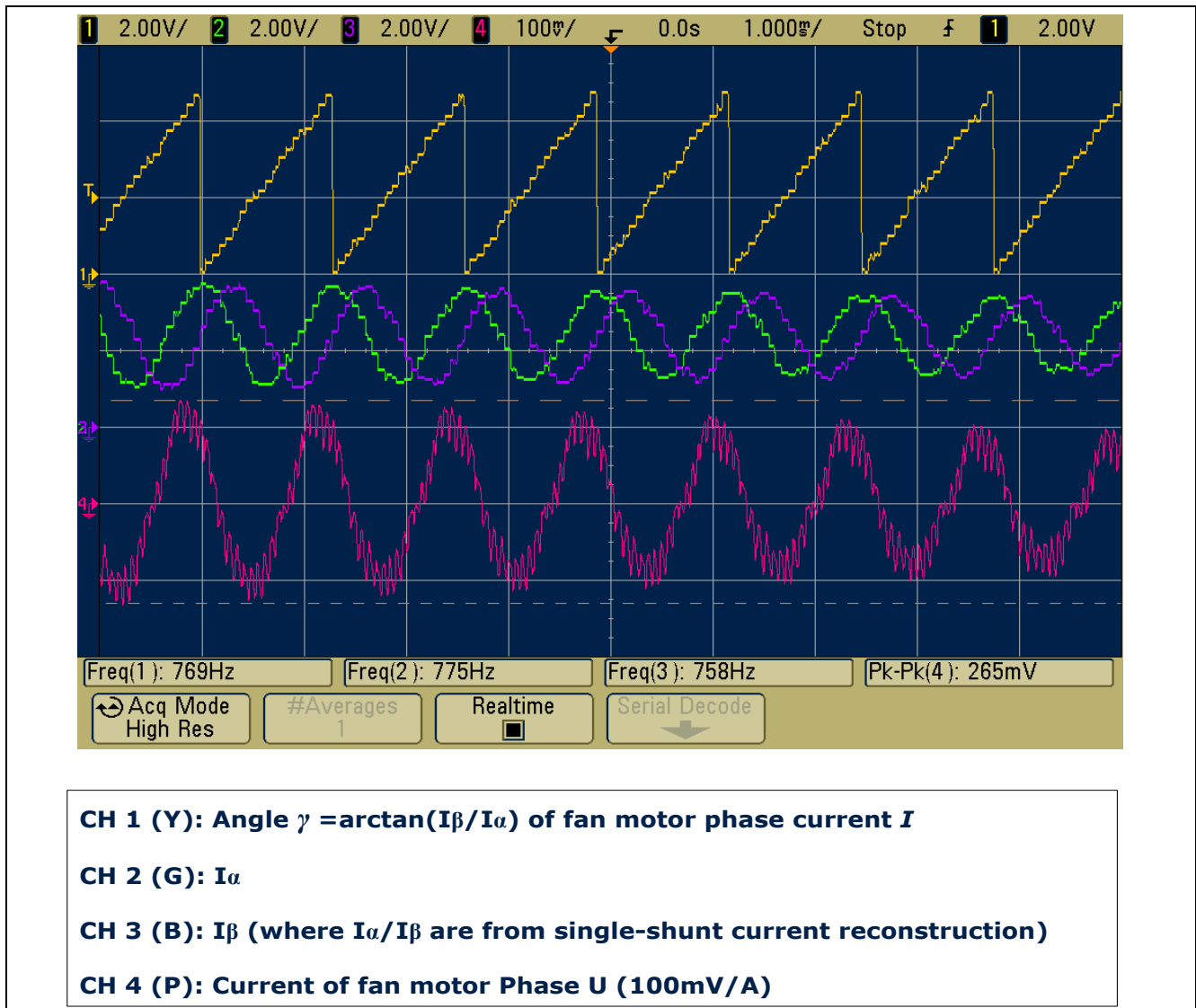


Figure 14 Motor Phase Current with constant high speed

The motor phase current waveform has a harmonic of PWM frequency of 15 kHz. The harmonic distortion is mainly due to the small phase inductance of the fan motor. By increasing the PWM frequency, the harmonic distortion could be reduced.

$$\omega = \frac{60 \times \gamma}{n} = \frac{60 \times 769 \text{ Hz}}{2}$$

$$\omega = 23,070$$

Where,

$\omega$  = Motor Speed (in rpm)

$n$  = No. of pole pairs

$\gamma$  = Angle (in Hz)

## 7.5 Start-up Lock Detection

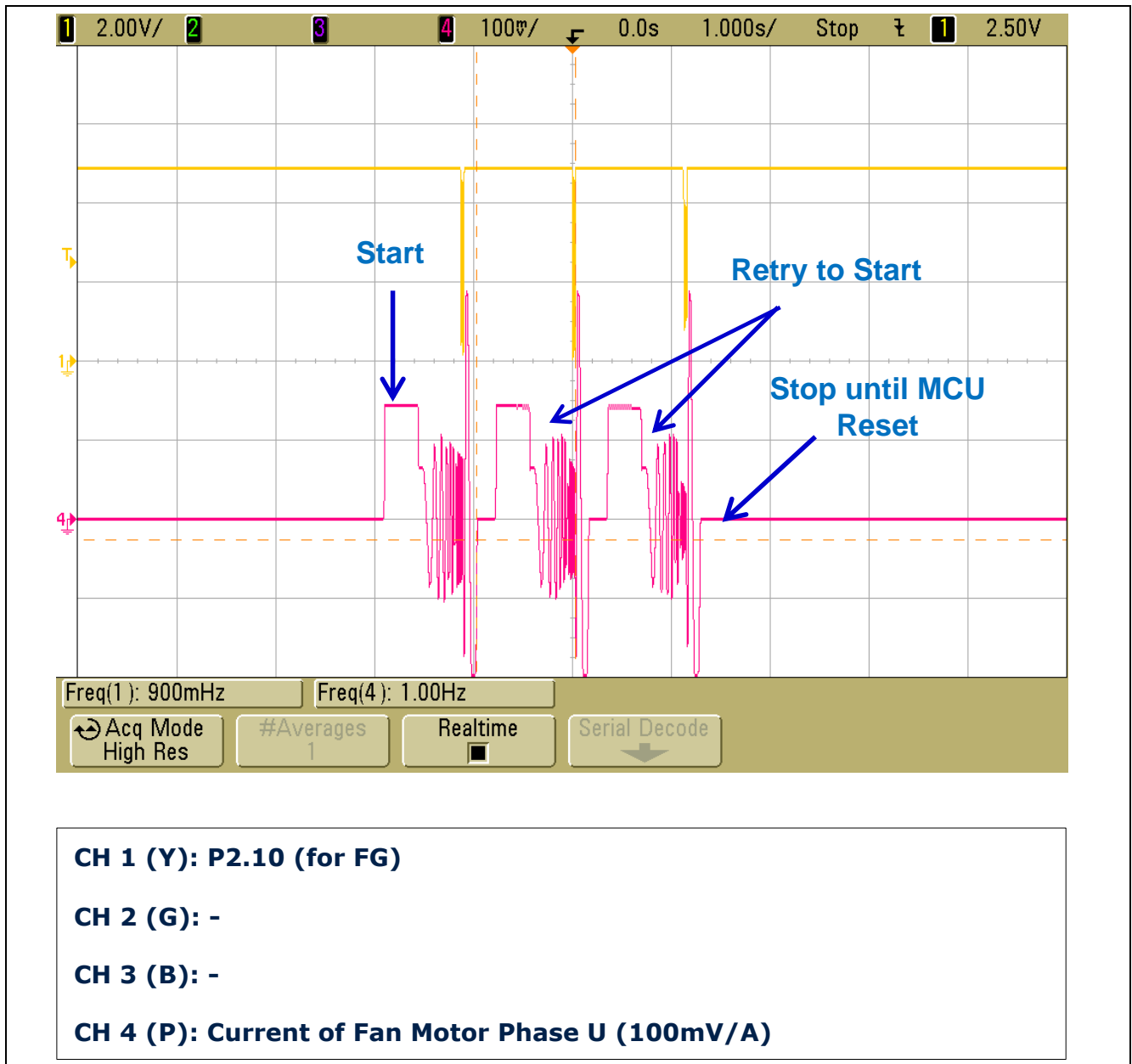


Figure 15 Phase Current Waveform during Start-up

The FG pin outputs a PWM waveform in the normal operation condition. During the start-up lock protection, FG output remains high until the motor restart. The retry process will only be stopped when the microcontroller power is reset.

## 8 Revision History

Current Version is V1.0, 2015-05

Page or Reference	Description of change
V1.0, 2015-03	
	Initial Version

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